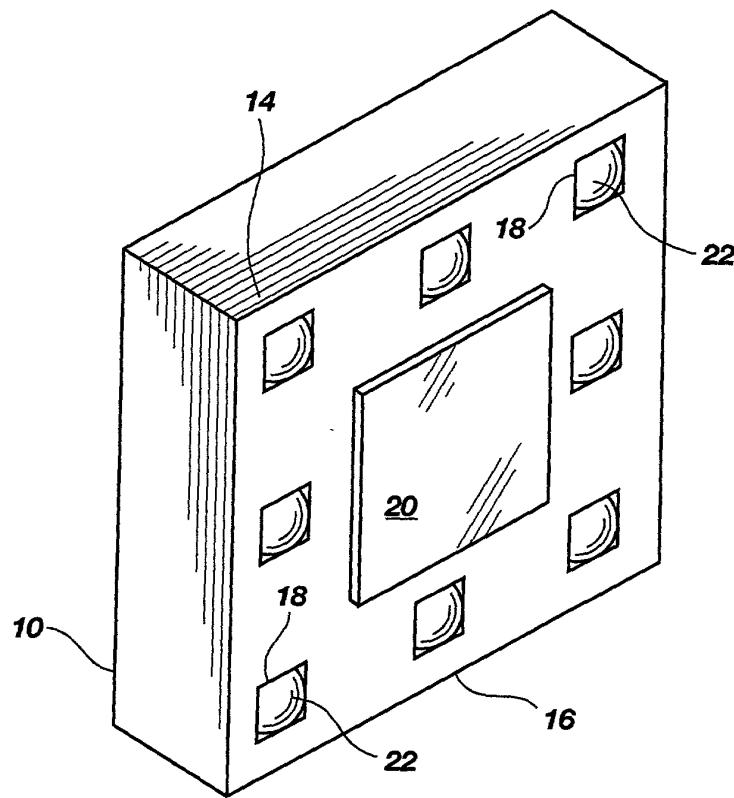
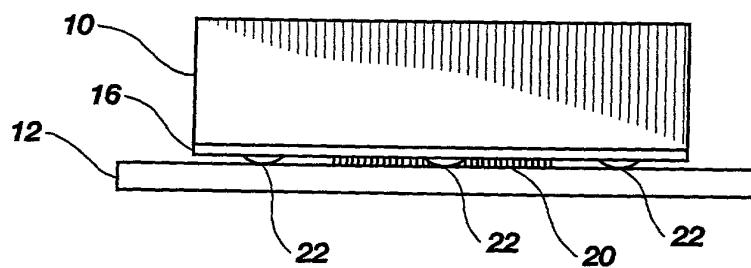


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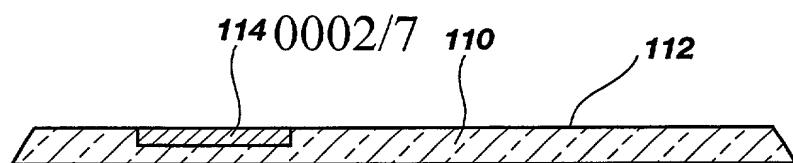
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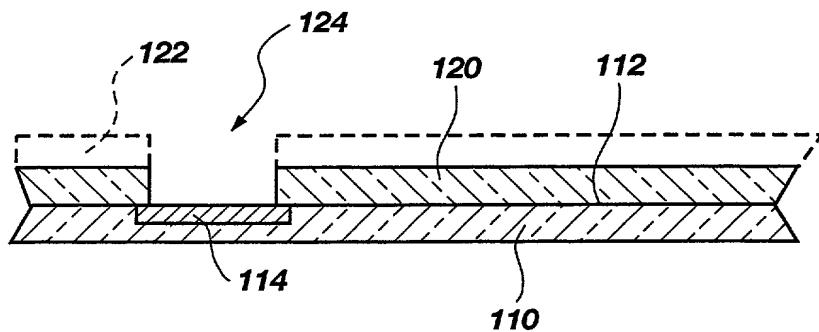
***Fig. 1(a)***  
**(PRIOR ART)**



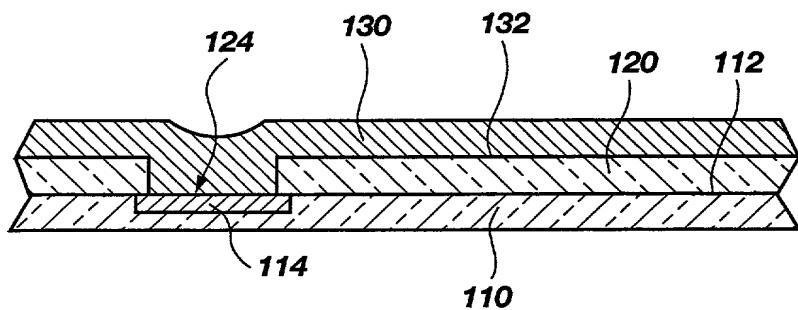
***Fig. 1(b)***  
**(PRIOR ART)**



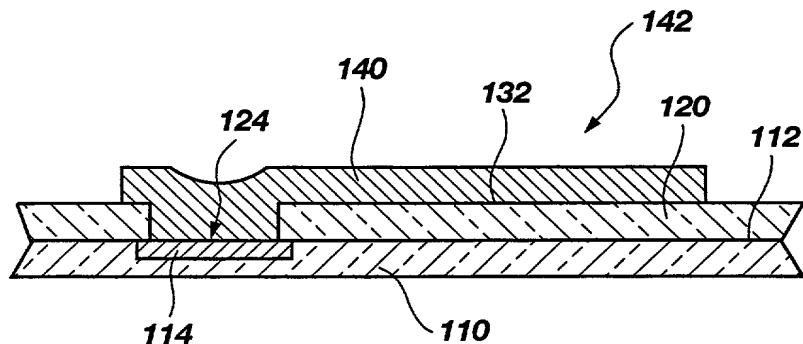
**Fig. 2(a)**



**Fig. 2(b)**

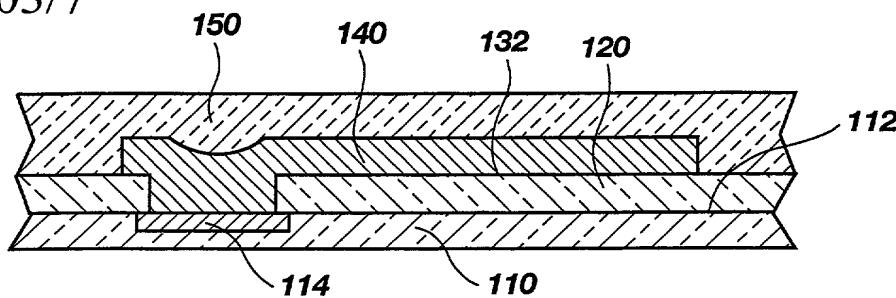


**Fig. 2(c)**

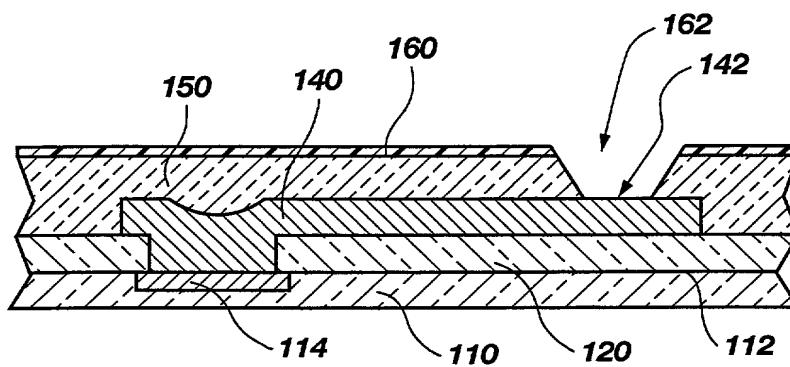


**Fig. 2(d)**

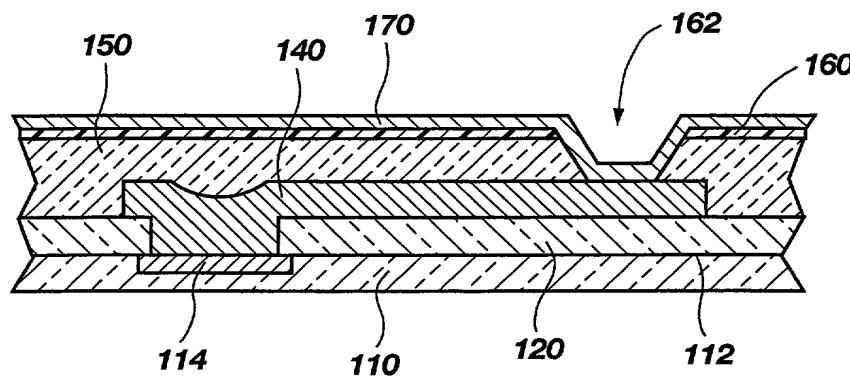
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**Fig. 2(e)**



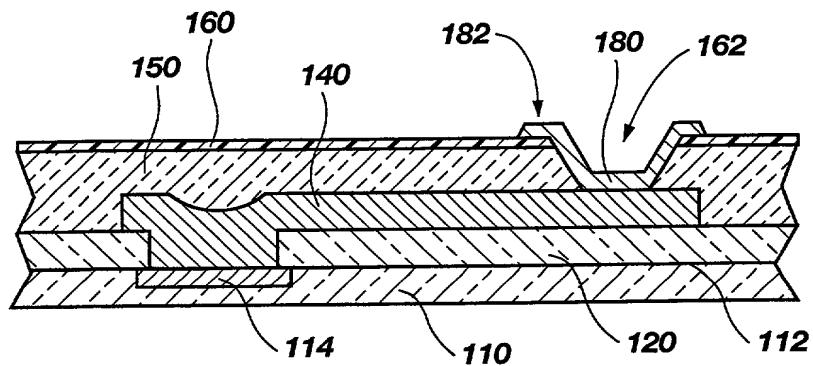
**Fig. 2(f)**



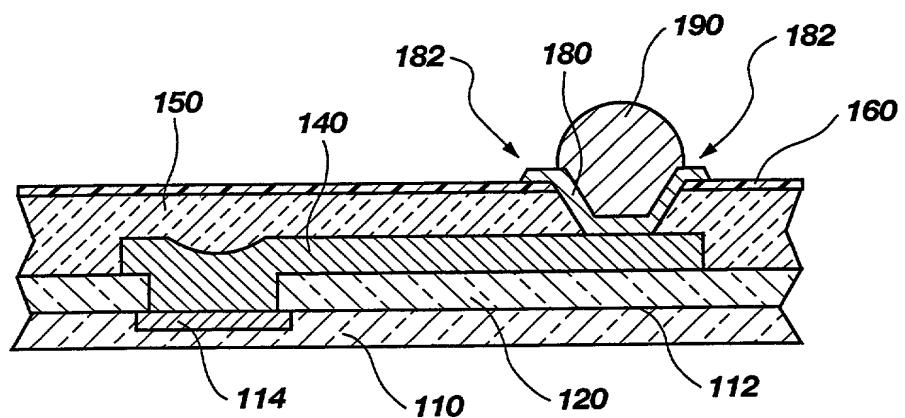
**Fig. 2(g)**

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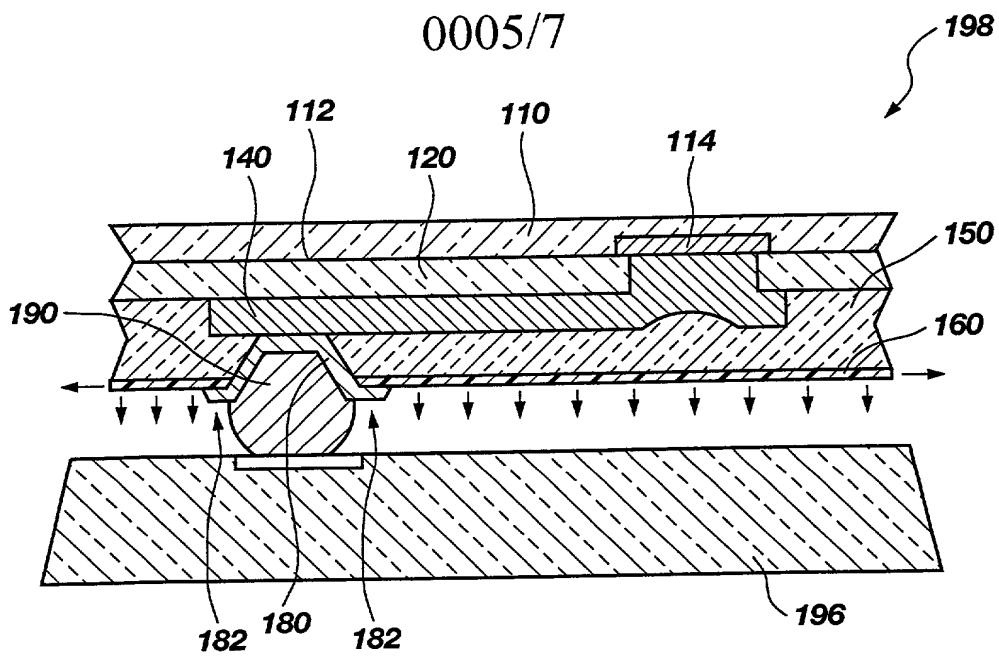
**Fig. 2(h)**



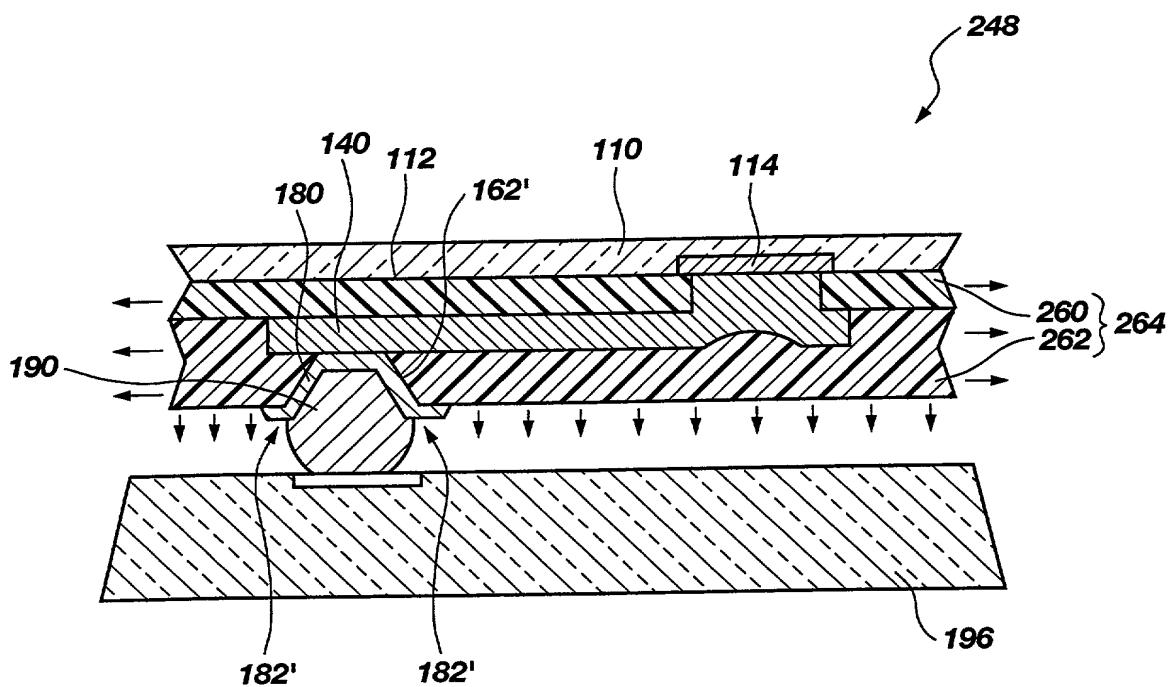
**Fig. 2(i)**

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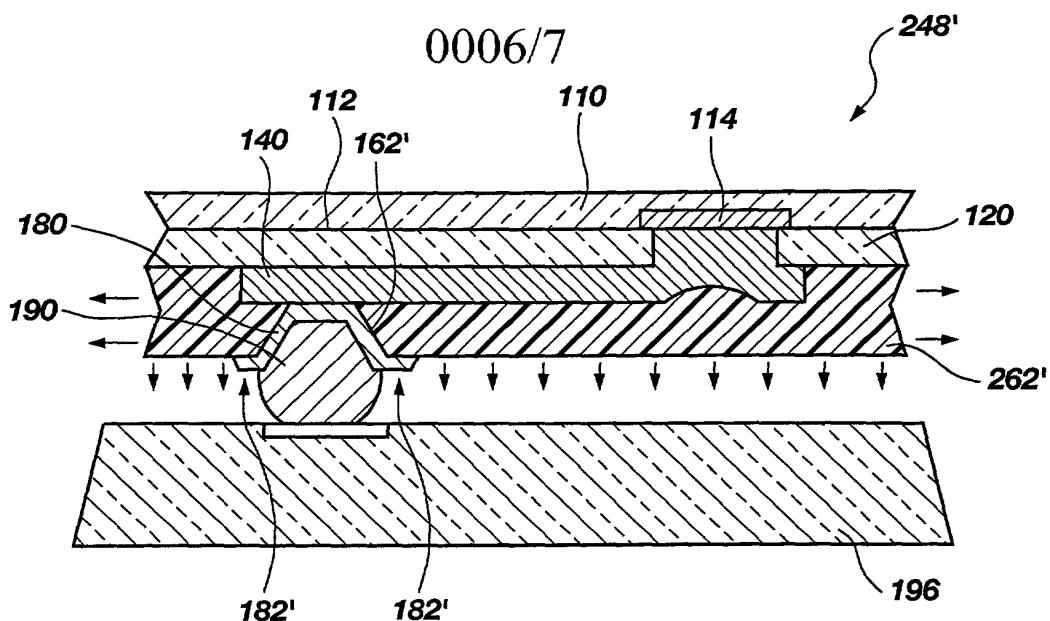


**Fig. 3**

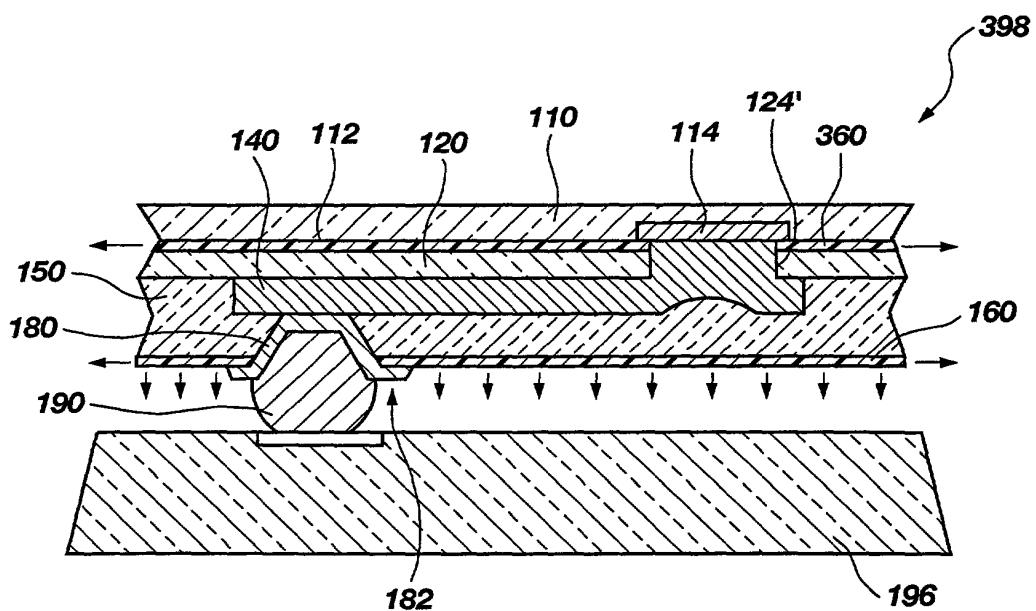


**Fig. 4**

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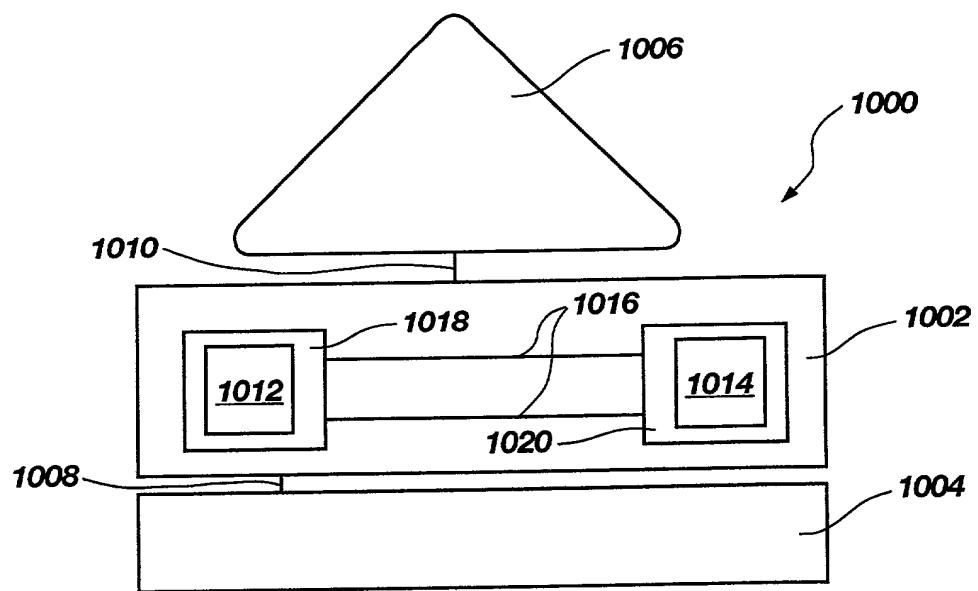
**Fig. 5**



**Fig. 6**

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*Fig. 7*